



## FEATURES

- Average Forward Current:  $I_{F(AV)}=1A$
- Polarity: Color band denotes cathode



## Package Marking and Ordering Information

| Product ID | Pack      | Marking | Qty(PCS) |
|------------|-----------|---------|----------|
| F1-F7      | SOD-123FL | F*      | 3000     |

\* : From 1-7

SOD-123FL



## MAXIMUM RATINGS (Ta=25 unless otherwise noted)

Rating 25°C ambient temperature unless otherwise specified.  
Single phase half wave, 60Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

| TYPE NUMBER   | F1       | F2  | F3  | F4  | F5  | F6  | F7   | UNITS |
|---|----------|-----|-----|-----|-----|-----|------|-------|
| Maximum Recurrent Peak Reverse Voltage  | 50       | 100 | 200 | 400 | 600 | 800 | 1000 | V     |
| Maximum RMS Voltage   | 35       | 70  | 140 | 280 | 420 | 560 | 700  | V     |
| Maximum DC Blocking Voltage   | 50       | 100 | 200 | 400 | 600 | 800 | 1000 | V     |
| Maximum Average Forward Rectified Current<br>at Ta=25°C   | 1.0      |     |     |     |     |     |      | A     |
| Peak Forward Surge Current, 8.3 ms single half sine-wave<br>superimposed on rated load (JEDEC method) | 30       |     |     |     |     |     |      | A     |
| Maximum Instantaneous Forward Voltage at 1.0A   | 1.3      |     |     |     |     |     |      | V     |
| Maximum DC Reverse Current<br>Ta=25°C   | 5.0      |     |     |     |     |     |      | μA    |
| at Rated DC Blocking Voltage<br>Ta=100°C  | 100      |     |     |     |     |     |      | μA    |
| Maximum Reverse Recovery Time (Note 1)  | 150      |     |     | 250 |     | 500 |      | nS    |
| Typical Junction Capacitance (Note 2)   | 15       |     |     |     |     |     |      | pF    |
| Typical Thermal Resistance R JA (Note 3)  | 80       |     |     |     |     |     |      | °C/W  |
| Operating and Storage Temperature Range Tj, Tstg  | -65—+150 |     |     |     |     |     |      | °C    |

### NOTES:

1. Reverse Recovery Time test condition:  $I_F=0.5A$ ,  $I_R=1.0A$ ,  $IRR=0.25A$
2. Measured at 1MHz and applied reverse voltage of 4.0V D.C.
3. Thermal Resistance from Junction to Ambient.



Typical Characteristics

FIG.1-TYPICAL FORWARD CHARACTERISTICS

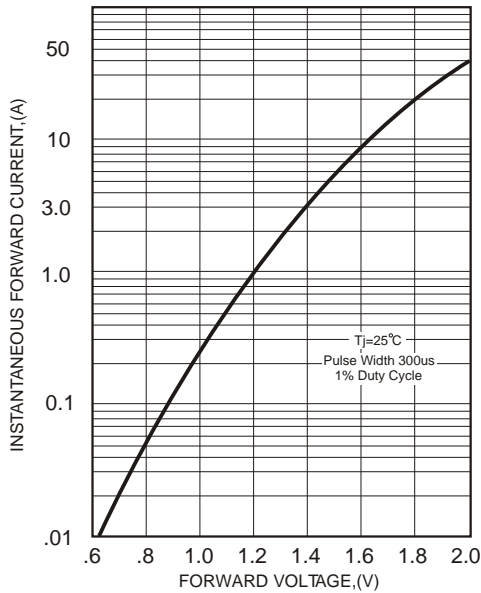


FIG.2-TYPICAL FORWARD CURRENT DERATING CURVE

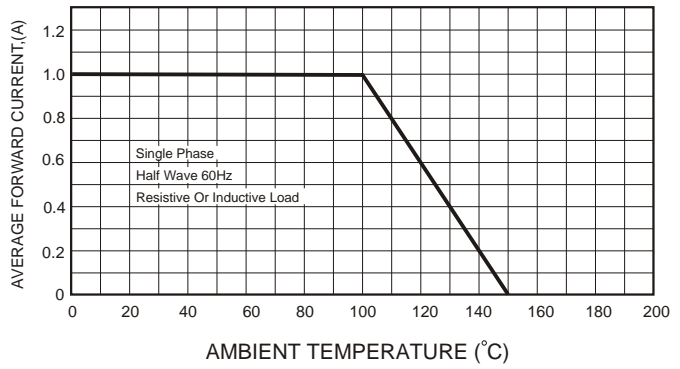
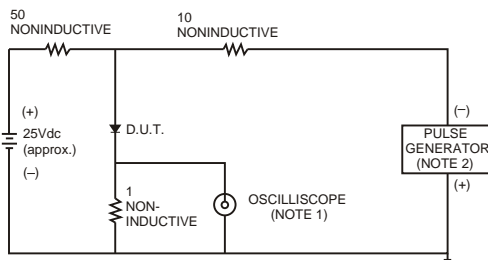


FIG.3- TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTICS



NOTES: 1. Rise Time= 7ns max., Input Impedance= 1 megohm,22pF.  
2. Rise Time= 10ns max., Source Impedance= 50 ohms.

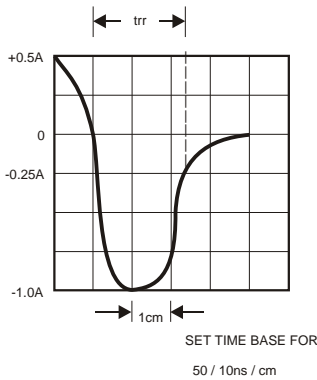


FIG.4-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

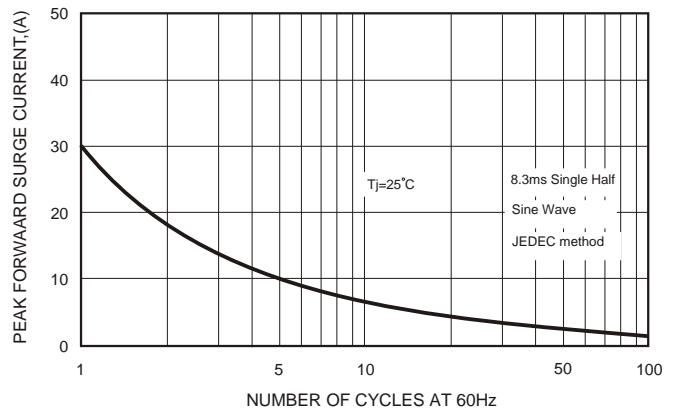
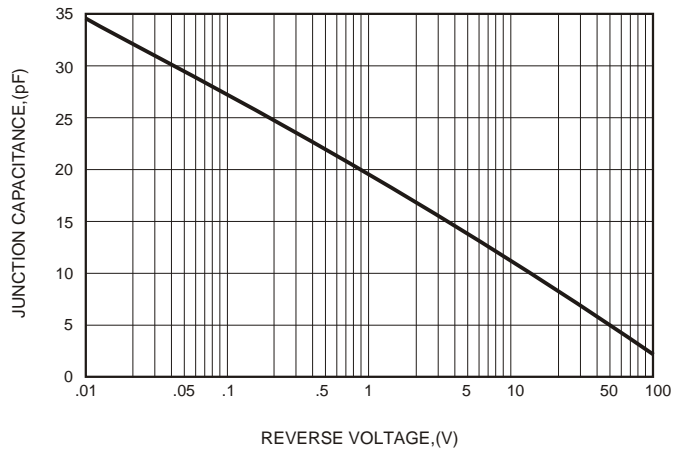
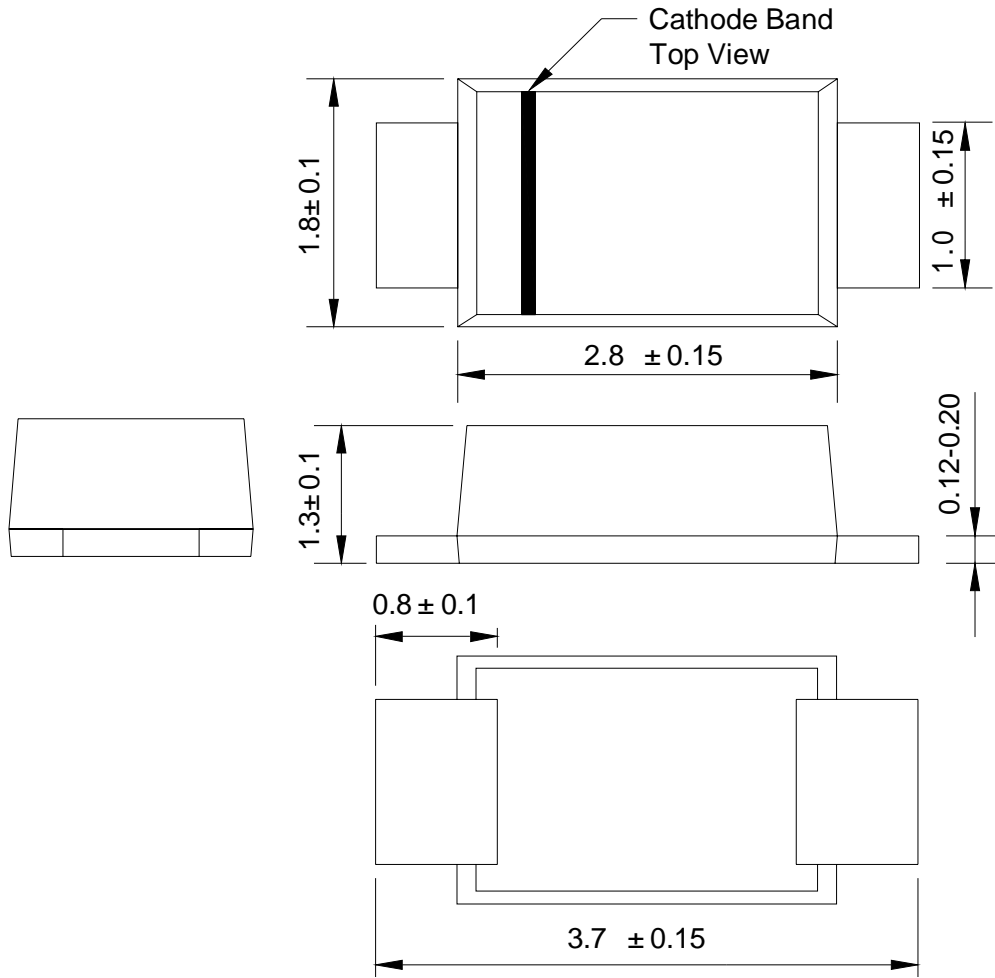


FIG.5-TYPICAL JUNCTION CAPACITANCE





### SOD-123FL Package Outline Dimensions





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